



60V N-CHANNEL ENHANCEMENT MODE MOSFET

Product Summary

BV _{DSS}	Rds(on)	I _D T _A = +25°C	
001/	68mΩ @ V _{GS} = 10V	8.5A	
60V	100mΩ @ V _{GS} = 4.5V	7.0A	

Description and Applications

This MOSFET is designed to meet the stringent requirements of automotive applications. It is qualified to AEC-Q101, supported by a PPAP, and is ideal for use in:

- Motor controls
- · Transformer driving switches
- DC-DC converters
- · Power-management functions
- · Uninterrupted power supplies

Features and Benefits

- 100% Unclamped Inductive Switch (UIS) Test in Production
- Low On-Resistance
- Fast Switching Speed
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- The DMN6068LK3Q is suitable for automotive applications requiring specific change control; this part is AEC-Q101 qualified, PPAP capable, and manufactured in IATF 16949 certified facilities.

https://www.diodes.com/quality/product-definitions/

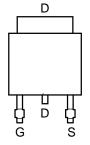
Mechanical Data

- Package: TO252
- Package Material: Molded Plastic, "Green" Molding Compound.
 UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals Connections: See Diagram
- Terminals: Matte Tin Finish Annealed over Copper Leadframe.
 Solderable per MIL-STD-202, Method 208 (3)
- Weight: 0.33 grams (Approximate)

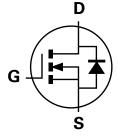




Top View



Pin Out — Top View



Equivalent Circuit

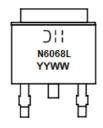
Ordering Information (Note 4)

Part Number	Paakaga	Packing		
Fait Number	Package	Qty.	Carrier	
DMN6068LK3Q-13	TO252 (DPAK)	2,500	Tape & Reel	

Notes:

- 1. EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. All applicable RoHS exemptions applied.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- $4. For packaging details, go to our website at {\it https://www.diodes.com/design/support/packaging/diodes-packaging/.} \\$

Marking Information



⊃¦¦ = Manufacturer's Marking
N6068L = Product Type Marking Code
YYWW = Date Code Marking
YY = Year (ex: 24 = 2024)
WW = Week (01 to 52)



Maximum Ratings (@TA = +25°C, unless otherwise specified.)

Characteristic			Symbol	Value	Unit
Drain-Source Voltage			V_{DSS}	60	V
Gate-Source Voltage		(Note 5) V _{GS}		±20	V
Single Pulsed Avalanche Ener	·gy	(Note 11)	Eas	37.5	mJ
Single Pulsed Avalanche Curr	Single Pulsed Avalanche Current		las	5.0	Α
	Vgs = 10V	(Note 7)	- I _D -	8.5	
Continuous Drain Current		$T_A = +70^{\circ}C \text{ (Note 7)}$		6.8	۸
Continuous Drain Current		(Note 6)		6.0	А
		$T_C = +25^{\circ}C \text{ (Note 12)}$		20	
Pulsed Drain Current	Vgs = 10V	(Note 8)	I _{DM}	22.2	A
Continuous Source Current (Body Diode) (Note 7)		(Note 7)	Is	10.2	A
Pulsed Source Current (Body Diode) (Note 8)		I _{SM}	22.2	А	

Thermal Characteristics (@TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit	
	(Note 6)		4.12 33	W mW/°C
Power Dissipation Linear Derating Factor	(Note 7)	P _D Linear Derating Factor	8.49 67.9	W mW/°C
	(Note 9)		2.12 16.9	W mW/°C
Power Dissipation	Tc = +25°C (Note 12)	PD	41	W
	(Note 6)		30.3	
Thermal Resistance, Junction to Ambient	(Note 7)	RθJA	14.7	
	(Note 9)		59.0	°C/W
Thermal Resistance, Junction to Lead (Note 10)		$R_{ heta JL}$	3.09	
Thermal Resistance, Junction to Case	(Note 12)	Rелс	3.03	
Operating and Storage Temperature Range	TJ, TSTG	-55 to +150	°C	

Notes: 5. AEC-Q101 V_{GS} maximum is ±16V.

^{6.} For a device surface mounted on 50mm × 50mm × 1.6mm FR4 PCB with high coverage of single-sided 2oz copper, in still air conditions; the device is measured when operating in a steady-state condition.

^{7.} Same as note 6 except the device is measured at $t \le 10$ sec.

Same as note 6 except the device is measured at t ≤ 10 sec.
 Same as note 6 except the device is pulsed with D = 0.02 and pulse width 300µs. The pulse current is limited by the maximum junction temperature.
 For a device surface mounted on 25mm x 25mm x 1.6mm FR4 PCB with high coverage of single-sided 1oz copper, in still air conditions; the device is measured when operating in a steady-state condition.

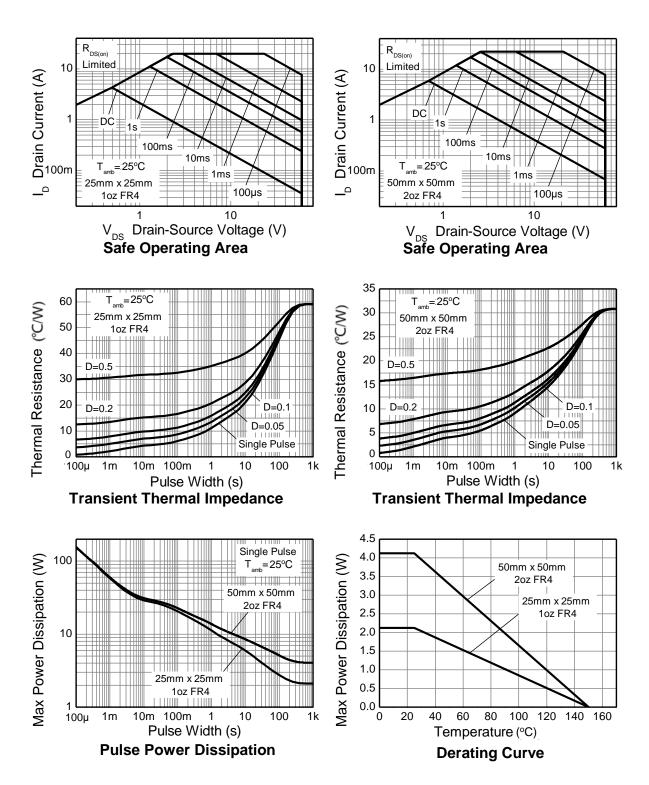
^{10.} Thermal resistance from junction to solder-point (at the end of the drain lead).

^{11.} UIS in production with L = 3.0mH, I_{AS} = 5.0A, R_G = 25 Ω , V_{DD} = 50V, starting T_J = +25°C.

^{12.} Thermal resistance from junction to soldering point (on the exposed drain pad).



Thermal Characteristics





Electrical Characteristics (@TA = +25°C, unless otherwise specified.)

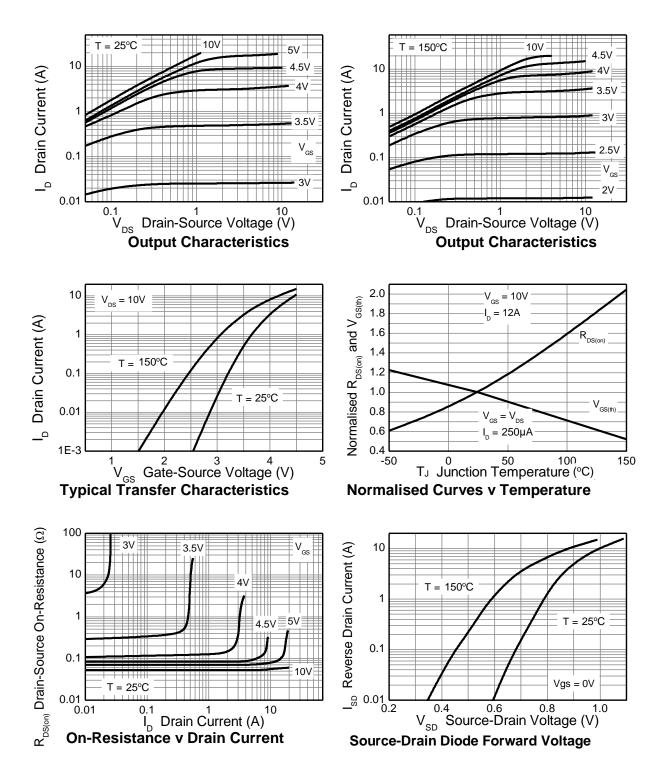
Characteristic	Symbol	Min	Тур	Max	Unit	Test C	Condition	
OFF CHARACTERISTICS								
Drain-Source Breakdown Voltage	BV _{DSS}	60	_	_	V	$I_D = 250 \mu A, V_{GS} = 0 V$		
Zero Gate Voltage Drain Current	I _{DSS}	_	_	0.5	μA	$V_{DS} = 60V, V_{GS}$	= 0V	
Gate-Source Leakage	lgss	_	_	±100	nA	$V_{GS} = \pm 20V, V_{D}$	s = 0V	
ON CHARACTERISTICS								
Gate Threshold Voltage	Vgs(TH)	1.0	_	3.0	V	$I_D = 250 \mu A, V_{DS}$	s = Vgs	
Static Drain-Source On-Resistance (Note 13)	D-2 (2)			0.068	Ω	V _G S = 10V, I _D =	12A	
Static Dialii-Source Oil-Resistance (Note 13)	Rds (ON)		_	0.100	\$2	Vgs = 4.5V, ID =	: 6A	
Forward Transconductance (Notes 13 & 14)	g fs		19.7	_	S	V _{DS} = 15V, I _D =	V _{DS} = 15V, I _D = 12A	
Diode Forward Voltage (Note 13)	VsD	_	0.98	1.15	V	Is = 12A, VGS =	0V	
Reverse recovery time (Note 14)	trr		145	_	ns	I _S = 12A, di/dt = 100A/μs		
Reverse recovery charge (Note 14)	Qrr		929	_	nC			
DYNAMIC CHARACTERISTICS (Note 14)								
Input Capacitance	Ciss		502		pF	.,	0) (
Output Capacitance	Coss		45.7	_	pF	V _{DS} = 30V, V _{GS} f = 1MHz	= 0V	
Reverse Transfer Capacitance	C _{rss}		27.1	_	pF	-1 = 1MHZ		
Total Gate Charge	Qg	_	5.55	_	nC	V _{GS} = 4.5V		
Total Gate Charge	Qg	_	10.3	_	nC		V _{DS} = 30V	
Gate-Source Charge	Qgs	_	1.6	_	nC	V _{GS} = 10V		
Gate-Drain Charge	Qgd		3.5	_	nC			
Turn-On Delay Time (Note 15)	tD(ON)	_	3.6	_	ns		•	
Turn-On Rise Time (Note 15)	t _R	_	10.8	_	ns	$V_{DD} = 30V, \ V_{GS} = 10V$ $I_{D} = 12A, \ R_{G} \cong 6.0\Omega$		
Turn-Off Delay Time (Note 15)	tD(OFF)	_	11.9		ns			
Turn-Off Fall Time (Note 15)	tF		8.7	_	ns			

Notes:

^{13.} Measured under pulsed conditions. Pulse width ≤ 300µs; duty cycle ≤ 2%.
14. For design aid only, not subject to production testing.
15. Switching characteristics are independent of operating junction temperatures.

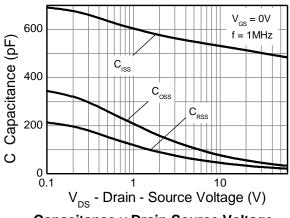


Typical Characteristics

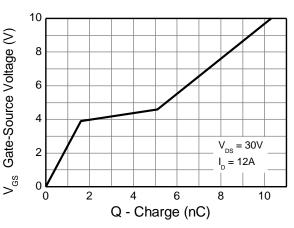




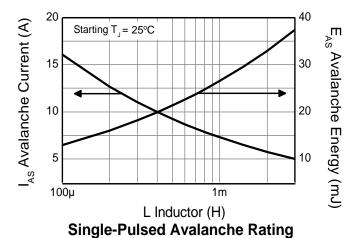
Typical Characteristics (continued)



Capacitance v Drain-Source Voltage

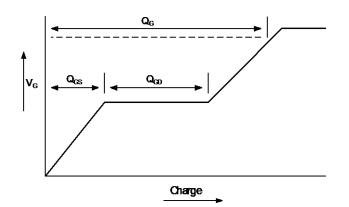


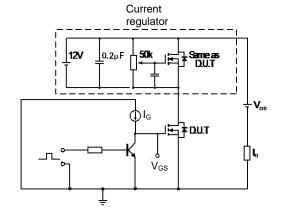
Gate-Source Voltage v Gate Charge





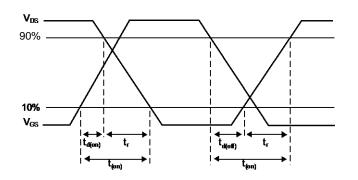
Test Circuits

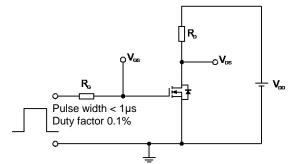




Basic Gate Charge Waveform

Gate Charge Test Circuit





Switching Time Waveforms

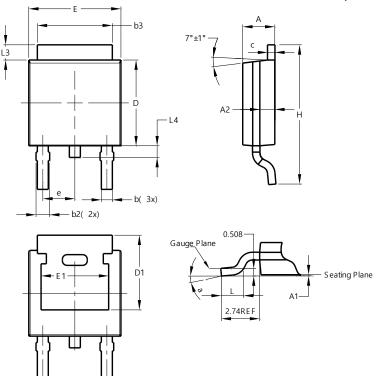
Switching Time Test Circuit



Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

TO252 (DPAK)

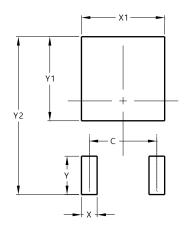


TO252 (DPAK)				
Dim	Min	Max	Тур	
Α	2.19	2.39	2.29	
A 1	0.00	0.13	0.08	
A2	0.97	1.17	1.07	
b	0.64	0.88	0.783	
b2	0.76	1.14	0.95	
b3	5.21	5.50	5.33	
C	0.45	0.58	0.531	
D	6.00	6.20	6.10	
D1	5.21			
е	2.	286 BS	C	
Е	6.45	6.70	6.58	
E1	4.32			
Н	9.40	10.41	9.91	
L	1.40	1.78	1.59	
L3	0.88	1.27	1.08	
L4	0.64	1.02	0.83	
а	0°	10°		
All Dimensions in mm				

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

TO252 (DPAK)



Dimensions	Value (in mm)	
С	4.572	
Х	1.060	
X1	5.632	
Υ	2.600	
Y1	5.700	
Y2	10.700	



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DMN6068LK3Q 9 of 9
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